# 2SK2144

# Silicon N-Channel MOS FET

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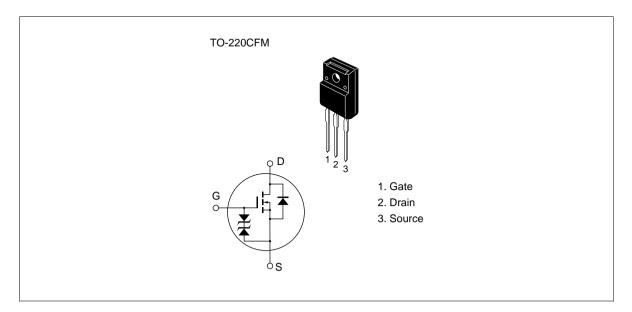
#### Application

High speed power switching

#### Features

- Low on-resistance
- High speed switching
- Low drive current
- No Secondary Breakdown
- Suitable for Switching regulator, DC-DC converter

#### Outline





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# **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	600	V	
Gate to source voltage	V <sub>GSS</sub>	±30	V	
Drain current	I <sub>D</sub>	3	А	
Drain peak current	I <sub>D(pulse)</sub> *1	6	А	
Body to drain diode reverse drain current	I <sub>DR</sub>	3	А	
Channel dissipation	Pch*2	25	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1 %

2. Value at Tc = 25 °C

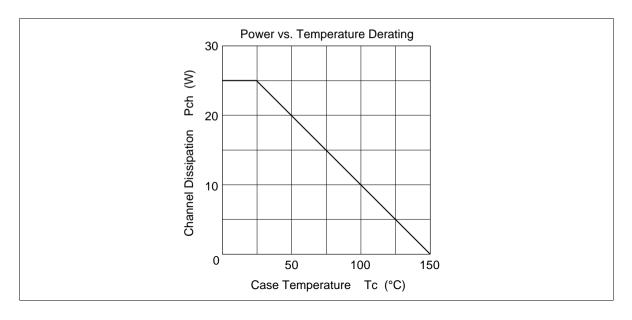
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# **Electrical Characteristics** (Ta = $25^{\circ}$ C)

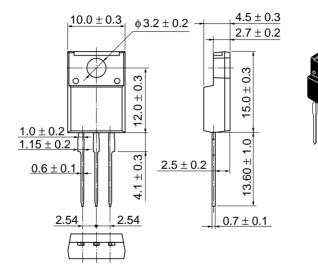
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{\rm (BR)DSS}$	600	—	—	V	$I_{\rm D} = 10$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(\text{BR})\text{GSS}}$	±30	—	—	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	250	μΑ	$V_{\rm DS} = 500 \text{ V}, \text{ V}_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0		3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	_	3.8	5.0	Ω	$I_{\rm D} = 1 \text{ A}$ $V_{\rm GS} = 10 \text{ V}^{*1}$
Forward transfer admittance	y <sub>fs</sub>	1.2	2.0	—	S	$I_{\rm D} = 1 \text{ A}$ $V_{\rm DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	_	295	_	pF	V <sub>DS</sub> = 10 V
Output capacitance	Coss	_	70		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	12		pF	f = 1 MHz
Turn-on delay time	t <sub>d(on)</sub>	_	8		ns	I <sub>D</sub> = 1 A
Rise time	t <sub>r</sub>	_	25		ns	V <sub>GS</sub> = 10 V
Turn-off delay time	$t_{d(off)}$	_	65		ns	$R_{L} = 30 \Omega$
Fall time	t <sub>f</sub>	_	30		ns	
Body to drain diode forward voltage	$V_{DF}$	_	0.9	—	V	$I_{F} = 2 A, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	220	—	ns	$I_F = 2 \text{ A}, V_{GS} = 0,$ $di_F / dt = 100 \text{ A} / \mu \text{s}$
recovery time Note 1. Pulse Test						

See characteristic curve of 2SK1572.

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Unit: mm



Hitachi Code	TO-220CFM
JEDEC	
EIAJ	
Weight (reference value)	1.9 g

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